



To the Honorable Commissioner of Patents and Trademarks:
Please record the attached original documents or copy thereof.

ATTN. BOX ASSIGNMENTS

1. Name of conveying party(ies):
1. Hiroshi MATOBA
2. Ryoichiro UEHARA
Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies):
Name: YKK Corporation
Internal Address: _____
Street Address: No. 1, Kanda Izumi-cho,
Chiyoda-ku, Tokyo, Japan
City: _____
State: _____ Zip Code: _____
Additional name(s) & Address(es) attached?
 Yes No

J1046 U.S. PTO
09/839172
04/23/01

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other
Execution Date: March 28, 2001

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application: March 28, 2001
A. Patent Application Number(s): _____
B. Patent Number(s): _____
Additional numbers attached? Yes No

09/839172

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: Mr. Ernest F. Chapman
Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT
& DUNNER, L.L.P.
Street Address: 1300 I Street, N.W.
City: Washington
State: DC Zip: 20005-3315

6. Total number of applications and registrations involved: 1
7. Total fee (37 CFR 3.41): \$40

Enclosed (Please charge deficiency to deposit account)

Authorized to be charged to deposit account
8. Deposit account number: 06-0916

9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
Ernest F. Chapman [Signature] April 23, 2001
Reg. No. 25,961 Signature Date
Total number of pages including cover sheet, attachments and documents: 3

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), Hiroshi MATOBA and Ryoichiro UEHARA (hereinafter referred to as Assignors) have made an invention entitled:

SWIVEL SNAP HOOK OF SYNTHETIC RESIN

for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on _____, (Serial No. _____); and

WHEREAS, YKK CORPORATION, a corporation of Japan whose post address is No.1, Kanda Izumi-cho, Chiyoda-ku, Tokyo, Japan(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOWHEREFORE, be it known that for and in consideration of the sum of One Dollar(\$1.00)in hand paid and other good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/We, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, provisional application Serial No. _____, filed _____(if any), and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of the above provisional application (if any) , as well as all rights to claim priority on the basis of this application, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

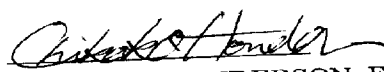
AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

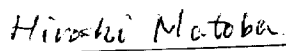
IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Country of Japan
Pref. of Toyama-ken ss.

Witness:
Name Chikako HONDA

Signature 

Assignor's:
Name Hiroshi MATOBA
Address 1262, Hikatae, Toyama-shi,
Toyama-ken, Japan

Signature 
Date March 28, 2001

Country of Japan)
Pref. of Toyama-ken) ss.

Assignor's:
Name Ryoichiro UEHARA
Address 115, Tenjinshin, Kurobe-shi,
Toyama-ken, Japan

Witness:
Name Chikako HONDA

Signature Ryoichiro Uehara
Date March 28, 2001

Signature Chikako Honda